Arrakis MK3 Series

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1 Copyright

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We reserve the right to revise this document or make changes in the specifications of the product described therein at any time without notice and without obligation to notify any person of such revision or change.



2 Regulatory Compliances

2.1 CE and UKCA Notice

This device complies with the requirements of the CE directive and UKCA regulations.

Low Voltage Directive 2014/35/EU + Electrical Equipment Safety Regulations 2016 (SI 2016 No 1101)

• EN 62368-1 :2014+A11:2017

EMC Directive 2014/30/EU + Electromagnetic Compatibility Regulations 2016

- EN 50121-4:2016+A1:2019
- EN 61000-6-4:2007+A1:2011
- EN IEC 61000-3-3:2013+A1:2019
- EN 61000-3-3:2013+A1:2019
- EN 61000-4-2:2009
- EN 61000-4-3:2006+A1:2008+A2:2010
- EN 61000-4-4:2012
- EN 61000-4-5:2014+A1:2017
- EN 61000-4-6:2014+AC:2015
- EN 61000-4-8:2010
- BS EN 50121-4:2016+A1:2019
- BS EN 61000-6-4:2014
- BS EN IEC 61000-3-2:2013+A1:2019
- BS EN 61000-3-3:2013+A1:2019
- BS EN 61000-4-2:2009
- BS EN 61000-4-3:2006+A2:2010
- BS EN 61000-4-4:2012
- BS EN 61000-4-5:2014+A1:2017
- BS EN 61000-4-6:2014
- BS EN 61000-4-8:2010

RoHS 2 Directive 2011/65/EU & 2015/863/EU + RoHS 2 Directive 2020 No. 1647

RoHS 2 Directive 2011/65/EU & 2015/863/EU

Exemption(s) used:

6a, 6b, 6c

RoHS 2 Directive 2020 No. 1647

Exemption(s) used:

No. 12, 15, 18



2.2 FCC PART 15 VERIFICATION STATEMENT

WARNING

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Notice: The changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

May contain transmitter module:

• N7NMC7455

2.3 ICES-003 ISSUE 7 VERIFICATION STATEMENT

CAN ICES3(A)/NMB3(A)

This device complies with CAN ICES-003 Issue 7 Class A. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. Cet appareil est conforme à la norme CAN ICES-003 Issue 7 Class A. Le fonctionnement est soumis auxdeux conditions suivantes : (1) cet appareil ne doit pas causer d'interférences nuisibles et (2) cet appareil doit accepter toute interférence reçue, y compris les interférences pouvant opération indésirable.

May contain transmitter module:

• 2417C-MC7455



3 Safety Instructions

Please carefully read and retain these safety instructions for future reference:

- 1. **Cleaning**: Disconnect this equipment from the power outlet before cleaning. Avoid using liquid or spray detergents; instead, opt for a damp cloth.
- 2. Humidity: Protect this equipment from humid environments.
- 3. **Power Cord Safety**: Arrange the power cord so it is not a tripping hazard and ensure it is not compressed or punctured by items placed upon it.
- 4. Cautions and Warnings: Adhere to all cautions and warnings noted on the equipment.
- 5. Long-Term Storage: Disconnect the equipment from the main power supply if it is not in use for extended periods to protect it from transient over-voltages.
- 6. Voltage Requirements: Continuous use at voltages lower than 9V could damage the power supply unit (PSU) or the mainboard.
- 7. Liquid Exposure: Avoid introducing any liquids into the equipment as this could lead to fire or electric shock.
- 8. Service and Repair:
 - Seek professional service if the power cord or plug is damaged, liquid has entered the equipment, it has been exposed to moisture, it does not operate correctly, or has been physically damaged.
- 9. **Temperature Extremes**: Avoid leaving equipment in uncontrolled environments where storage temperatures could fall below -20°C or exceed 60°C, as this may cause damage.
- 10. Servicing: Unplug the power cord when performing any form of service or when installing optional kits.
- 11. Lithium Battery Warning:
 - There is a risk of explosion if the battery is replaced incorrectly. Use only the type recommended by the manufacturer and follow the manufacturer's disposal instructions.
 - Do not attempt to open the equipment's cover as it contains no user-serviceable parts. All servicing should be performed by qualified service personnel.



4 Product Introduction

4.1 About Arrakis MK3

Thank you for selecting the Welotec ARRAKIS MK3. The ARRAKIS MK3 is a robust, fanless embedded system designed for industrial computing applications. It utilizes industrial-grade components to ensure reliable operation in extreme and critical environments.

The ARRAKIS MK3 is equipped with a 1.6/2.0 GHz Quadcore Intel Atom[®] Processor E3950. The standard model includes a SoDIMM socket that supports 1866MHz DDR3L memory, enhancing its performance capabilities.

This system supports high-resolution display outputs through 1x HDMI and 1x Display Port, capable of handling resolutions up to 4K. It includes mSATA storage and one FullSize mPCIe socket. An optional expansion module can add 2x FullSize mPCIe sockets with USB and 2 external SIM sockets for enhanced connectivity. It also features four USB 3.0 ports, dual Gigabit-LAN, and customizable options such as CAN-Bus, Digital I/O, WLAN, and WWLAN, catering to various industrial needs. Additionally, it supports up to four COM ports.

The ARRAKIS MK3's versatile mounting options, including quick-setup wall mount and DIN mount, coupled with its durable aluminum housing and dust-proof design, make it an ideal choice for demanding industrial environments. This combination of durability, flexibility, and high-performance capabilities ensures that the ARRAKIS MK3 meets the needs of complex and critical industrial applications.

4.2 Product Specifications



4.2.1 Technical Details

Feature	Specification	Details	
Processor CPU Intel Atom® Quadcore E395		Intel Atom [®] Quadcore E3950, 1.6/2.0 GHz (Standard)	
Memory RAM		1866 MHz DDR3L SoDIMM, expandable up to 8GB	
Display	Max. Resolution	Supports DP + HDMI, up to 4K resolution	
Storage Options		2.5" SATA 3.0 drive bay (optional), mSATA connector	
I/O Ports	Display Ports	1 DisplayPort, 1 HDMI port	
	LAN	2 RJ45 Gigabit Ethernet ports	
	USB 3.0	4 ports	
	Serial Ports	2 RS232/422/485, optional expansion for 2 additional	
Networking	Ethernet	Dual Intel i210IT LAN chip (Gigabit)	
	WLAN	Optional, via mPCIe	
	WWAN	Optional 4G/5G via USB	
Expansion	SIM Slots	2 push-push type SIM slots (available with 4G/5G modules)	
Additional	Audio and Other	Line in/out, Digital I/O, CAN (optional)	
	Watchdog Timer	Programmable from 1 to 255 seconds	
Environmental	Operating Temperature	-20° to 70° C	
	Storage Temperature	-20° to 80° C	
	Humidity	5% to 95% non-condensing	
Power	Supply	9-36V DC, 4-pin terminal block and DC jack	
	Adapter	Optional 60W, 24V/5A external, CR1220 CMOS battery	
Mounting	Options	Optional DIN Rail Mounting Kits	
Operating System	Compatibility	Windows 10, Ubuntu Linux, others upon request	
Physical Build	Material/Color	Aluminum / Steel, Silver	
	Dimensions	64 x 140 x 92 mm	
Compliance	Regulatory	CE Certified	



5 System Information

5.1 System Drawing







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Bottom side



Top side



Rear side



5.2 Mainboard Block Diagram

This block diagram describes the relationship among all interfaces and modules on the mainboard.





5.3 System





6 Mainboard Overview

6.1 Mainboard Layout Overview



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6.2 Jumper Descriptions

Jumper Configurations:

- JSB1: Clears CMOS data
- JVL1: Selects power for the LCD panel
- JVC1/JVC2: Configures COM1/2 ring indicator and power selection

6.3 Jumper Settings Explained

Jumpers manage electrical connections on a mainboard. A jumper is set to "ON" when a plastic cap bridges two pins, creating a closed circuit. It is set to "OFF" when the cap is removed, opening the circuit. Some jumpers include three pins (1, 2, and 3), allowing configurations between pins 1-2 or 2-3. The illustration below demonstrates



various jumper settings:

All jumpers are preset to their default configurations, marked with an asterisk (*) in this guide, either as ON (with cap) or OFF (without cap).

6.4 Detailed Jumper Settings

6.4.1 JSB1: CMOS Data Reset

To maintain or clear the motherboard's CMOS settings:

- 1. Power off the system and disconnect all power sources.
- 2. Disconnect the 12V DC power cable.
- 3. Set JSB1 jumper between pins 1 and 2 to clear CMOS.
- 4. Reset JSB1 to its default setting (typically pin 1-2 closed).
- 5. Reconnect the 12V DC power cable.

This procedure is typically used for troubleshooting or if the BIOS password is forgotten.



JSB1	
1 2 3	1 2 3
'Normal	CMOS

2 3



JSB1	Description
*1-2	Normal set
2-3	CMOS data clear

JSB1 Illustrations:

6.4.2 JVL1: LCD Panel Power Selection

Adjust JVL1 to select the appropriate power setting for your LCD panel.



3

*+3.3V

3

2



JVL1	Description
1-2	+5V
*2-3	+3.3V

JVL1 Settings Visualization:

6.4.3 JVC1/JVC2: COM Port Configuration

Set JVC1 and JVC2 to configure power and signal settings for COM1 and COM2 ports.



JVC1/JVC2	DESCRIPTION	
*1-2	RI	
3-4	+5V	
5-6	+12V	



JVC2	
246	246
000	000
000	000
1 3 5	1 3 5
JVC1	
*RI Signal	+5V

2	4	6
0	Ο	(
	0	Ç
0	0	ζ
	Ο	¢
1	3	1
	_	

+12V

JVC1/JVC2 Configuration:



7 Connector Guide

This section provides a comprehensive overview of all connectors, switches, and indicators necessary for peripheral setup. Before installation, ensure the system is powered off and disconnected from any power sources.

7.1 Connector Overview

- BAT1: Holds a 3V lithium battery.
- CA3: Facilitates connections for Line-out, Line-in, Mic-in, and SPDIF-out via a 2x5 pin (2.0mm) wafer.
- CALR1: Connects right/left audio channels through a 4-pin (1.25mm) wafer for amplifier outputs.
- CC1 & CC2: Serial communication ports; CC1 features a DB9 connector, while CC2 utilizes a 2x5 pin (2.0mm) wafer.
- CBT1: 2-pin (1.25mm) wafer battery holder for a 3V lithium battery.
- CFP1: Front Panel control connector with a 2x5 pin (2.0mm) wafer.
- CIO1: Digital I/O connector via a 2x5 pin (2.0mm) wafer.
- CL1 & CL2: Network ports with RJ45 connectors for LAN connections.
- CO1: I2C bus connection via a 1x4 pin (1.25mm) wafer.
- CPI1 & CPO1: Power input and output connectors, respectively, with 4-pin (2.0mm) wafer configurations.
- CU3, CU4, CU12, CU5, CU6, CU7: Various USB ports for device connectivity and data transfer.
- LVDS1: Low-Voltage Differential Signaling connector, via a 2x15 pin (1.25mm).
- CPP1 & CT1: Connectors for backlight power and touch interface, respectively.
- SATA1: Provides connectivity for SATA storage devices.
- MPCE1 & MPCE2: Full-size Mini PCIe sockets for expanding functionalities.
- HDMI1 & HDMI2: Video output connectors for HDMI and Display Port.
- EIO1: Extended input/output port via a 2x20 pin (1.27mm) wafer.

7.1.1 Safety and Handling

- Safety: Always ensure the system is completely powered off and disconnected from any power source before connecting or disconnecting peripherals.
- Handling: Carefully handle connectors and avoid forceful insertion to prevent damage to pins and ports.

7.2 DC Power In





Pin	Description
0 (left)	9 – 36V+
1,2 (middle)	External Power Switch
3 (right)	Ground

7.3 CMOS Battery holder



PIN NO.	DESCRIPTION
1	GND
2	+3V

CBT1: 3V Battery Holder Specifications

- Connector: CBT1 is a 2-pin holder for a 3V Lithium battery.
- Battery Specifications: Uses a CR1220 Lithium battery, 3V/40mAh.

Note on Power Consumption:

- Without a connected power adapter: approximately 2.7 microamperes (uA).
- With a connected power adapter: approximately 0.1 microamperes (uA).

7.4 COM Ports

RS232 mode:



PIN NO.	Description	PIN NO.	Description
1	DCD	6	DSR
2	RXD	7	RTS
3	TXD	8	CTS
4	DTR	9	RI/Voltage
5	GND		

RS422 mode:

PIN NO.	Description	PIN NO.	Description
1	RS422 TX-	6	NC
2	RS422 TX+	7	NC
3	RS422 RX+	8	NC
4	RS422 RX-	9	NC
5	GND		

RS485 mode:

PIN NO.	Description	PIN NO.	Description
1	RS485 TX-	6	NC
2	RS485 TX+	7	NC
3	NC	8	NC
4	NC	9	NC
5	GND		

7.5 LAN Ports

PIN NO.	Description	PIN NO.	Description
1	TR0-/TX+	5	TR2-/NC
2	TR0+/TX-	6	TR2+/RX-
3	TR1-/RX+	7	TR3-/NC
4	TR1+/NC	8	TR3+/NC



7.6 USB Ports

PIN NO.	Description		
1	+5∨		
2	DATA -		
3	DATA +		
4	GND		

7.7 mPCIe MiniExpressCard

The Arrakis MK3 is equipped with four mPCIe connectors, enhancing its flexibility and connectivity options:

1. Full-size mPCIe Slots:

- Primary Slot: Typically preoccupied with an mSATA SSD, which is not readily available for other uses.
- Secondary Slot: Facilitates connections for USB, mSATA, and PCIe interfaces, offering versatile usage.
- 2. Additional Full-size mPCIe Slots:
 - These slots are configurable based on specific requirements, available either on demand or with a preinstalled 4G modem. Generally, one of these is dedicated to the 4G modem, limiting the other for USB device compatibility.



PIN NO.	Description	PIN NO.	Description
1	NC	2	+3.3V
3	NC	4	GND
5	NC	6	+1.5V
7	NC	8	NC
9	GND	10	NC
11	PCIe-CLK-	12	NC
13	PCIe-CLK+	14	NC
15	GND	16	NC
	KEY		
17	NC	18	GND
19	NC	20	NC
21	GND	22	Reset
23	PCIe-RX-/mSATA-RX+	24	+3.3V
25	PCIe-RX+/mSATA-RX-	26	GND
27	GND	28	+1.5V
29	GND	30	SMB-CLK
31	PCIe-TX-/mSATA-TX-	32	SMB-DATA
33	PCIe-TX+/mSATA-TX+	34	GND
35	GND	36	USB-DATA-
37	GND	38	USB-DATA+
39	+3.3V	40	GND
41	+3.3V	42	NC
43	GND	44	NC
45	NC	46	NC
47	NC	48	+1.5V
49	NC	50	GND
51	mSATA/PCIe detect	52	+3.3V









8 **BIOS Overview**

8.1 Introduction

The BIOS (Basic Input/Output System) serves as the fundamental bridge connecting the motherboard and operating system in your computer. It resides in the Flash Memory on the motherboard. When you start up the computer, the BIOS is the first to take control, initiating a series of checks known as the POST (Power-On Self Test) to ensure all hardware components are functioning properly. It identifies and configures hardware settings and prepares the system to hand over control to the operating system. The BIOS is crucial for system stability and optimal performance.

Within the BIOS setup menu, you'll find a range of options to configure. Below, we outline the function keys used to navigate and modify settings within the BIOS:

- Esc: Exit the BIOS setup.
- Arrow keys (↑↓ ← →): Navigate through options.
- F10: Save changes and exit.
- Page Up/Page Down or +/-: Adjust settings for selected options.

8.2 Accessing BIOS

To enter the BIOS setup:

- 1. Power on your computer and immediately press the Del key.
- 2. If you miss the initial prompt, restart your system by turning it off and on, or by pressing Ctrl, Alt, and Delete simultaneously to perform a soft reboot.



8.3 BIOS Menu Overview

. <u></u>	InsydeH20 S	etup Utility	Rev. 5.0
Hain Advanced Security Power	Boot Exit		
BIOS Version Build Date	2/392CW A1 02/12/2018 11:08:58		This is the help for the hour, ninute, second field. Valid range is from 0 to 23, 0 to 59, 0 to 59. INCREASE/REDUCE :
Processor Type System Bus Speed System Hemory Speed Cache RAH Intel Memory	Intel(R) Celeron(R) 100 MHz 1866 MHz 1024 KB 4096 Hp	CPU N3350 @ 1.10GHz	u/
Platform firmware information BXT SOC	B1 Stepping		
System Time System Date	[14:14:50] [03/06/2018]		
F1 Help 1/ Esc Exit +/	Select Iten Select Iten	F5/F6 Change Values Enter Select ► Sublienu	F9 Setup Defaults F10 Save and Exit

The BIOS main menu offers a range of configurable settings crucial for tailoring your system's operation. Here's how you can navigate through these options efficiently:

- Navigating Screens: Use the left (←) and right (→) arrow keys to switch between different settings screens.
- Selecting Options: Use the up (↑) and down (↓) arrow keys to highlight the specific option you want to adjust or confirm in the main menu.
- Modifying Values: Press Enter to select an option for modification. Use the plus (+) and minus (-) keys to adjust the values for the selected option.
- Shortcut Keys:
 - F1: Displays general help.
 - F2: Reverts to the previous value.
 - F3: Loads optimized default settings.
 - F4: Saves changes and resets the system.
 - Esc: Exits the BIOS Setup.



8.3.1 Menu Tabs:

- Main: Adjust basic system settings.
- Advanced: Modify advanced system configurations.
- Security: Set or change BIOS passwords.
- Power: Manage ACPI settings and power management options.
- Boot: Configure system boot options.
- Exit: Save changes or load default settings before exiting.

The selected tab is highlighted for easier navigation.

8.4 BIOS Help Feature

Access the BIOS Help window by pressing F1. This feature provides a detailed description of the function keys and their uses for the highlighted menu item. Press Esc to close the Help window.



8.5 Detailed Menu Options

	Insyd	eH20 Setup Utility	Rev. 5.0
Hain Advanced Security Pow	ver Boot Exit		
BIOS Version Build Date	2/392CW A1 02/12/2018 11:	08:58	This is the help for the hour, minute, second field. Valid range is from 0 to 23 0 to 59 0 to 59 INCREASE/DECOMPER-
Processor Type System Bus Speed System Henory Speed Cache RAM Total Henory	Intel(R) Celer 100 MHz 1866 MHz 1024 KB 4096 MB	an(R) CPU N3350 @ 1.10GHz	•/
Platforn firmware Information BXT SOC	B1 Stepping		
System Tine System Date	[14:14:50] [03/06/2018]		
F1 Help Esc Exit	1/1 Select Iten +/+ Select Iten	F5/F6 Change Values Enter Select ≻ Sublenu	F9 Setup Defaults F10 Save and Exit

The main menu screen displays basic system information and allows for easy configuration:

- System Date: Adjust the system date by using the Tab key to move between elements and the numerical keys to set the values.
- System Time: Set the system time in a similar manner, utilizing the Tab key for navigation and numerical keys for adjustments.

These settings help ensure that your system functions correctly and maintains accurate logs of system events and tasks.



8.6 Advanced BIOS Settings

Explore the configuration possibilities for your system's performance and functionality. Adjust settings to suit your hardware requirements and preferences.

8.6.1 Video Configuration

Advanced	Insyd	leH20 Setup Utility	Rev. 5.0
DDI Configuration DDIO Output DDII Output LVDS Output	<hdh1> <dp> <disabled></disabled></dp></hdh1>		
16D Configuration Aperture Size DYNT Pre-Allocated DYNT Total Gfx Hen	<256/18> <64/t> <256/t>		
F1 Help Esc Exit	1/1 Select item +/+ Select item	F5/F6 Change Values Enter Select ≻ Sublenu	F9 Setup Defaults F10 Save and Exit

Fine-tune the graphics performance by configuring the memory allocation:

- Aperture Size: Choose between 128MB, 256MB (default), or 512MB to optimize your system's graphics memory usage.
- IGD DVMT Pre-Allocated: Set the fixed allocation for the integrated graphics memory. Available options are 64MB (default), 128MB, 256MB, or 512MB to enhance video performance.
- IGD DVMT Total Gfx Mem: Adjust the total available graphics memory for the system, with choices of 128MB, 256MB (default), or the maximum supported by your hardware.



8.6.2 HD-Audio Configuration

	Ir	isydeH20 Setup Utility	Rev. 5	. 0
Advanced				
Advanced PHD=Audio Configuration PPCI Express Configuration PSATA Drives	Ir	isydeH2O Setup Utility	Rev. 5	
Fl Help Esc Exit	1/1 Select Item +/+ Select Item	F5/F6 Change Values Enter Select ► Sublienu	F9 Setup Defaults F10 Save and Exit	

Control audio capabilities to suit your media needs:

• HD-Audio Support: Toggle the high-definition audio to enhance your multimedia experience. Available settings are Enabled (default) and Disabled, allowing you to optimize audio performance according to your needs.



8.6.3 PCI Express Configuration

	Insyd	leH20 Setup Utility	Rev. 5.0
Advanced			
HPCEL / EIO P2 PCIe Speed HPCE/EIO Switch	<enabled> <auto> <tipce></tipce></auto></enabled>		Control the PCI Express Root Port. AUTO: To disable unused root port autonatically for the most optimum power savings. Enable: Enable PCIe root port Disable: Disable PCIe root port
Fl Help Esc Exit	1/1 Select Iten +/+ Select Iten	F5/F6 Change Values Enter Select + Sublienu	F9 Setup Defaults F10 Save and Exit

Configure the PCI Express settings to optimize connectivity and performance for expansion cards:

- MPCE1 / EIO P2: Enable or disable the MPCE1 slot with options for Disabled or Enabled (default), adapting to your hardware expansion needs.
- PCIe speed: Set the operational speed of the PCIe slots to match component specifications for optimal performance. Options include Auto (default), Gen1, and Gen2.
- MPCE / EIO Switch: Direct the PCIe signal either to the MPCE1 (default) or to the EIO, catering to different internal expansion needs for OEM I/O or function boards.



8.6.4 SATA Drives Configuration

	InsydeH20 Set	up Utility	Rev. 5.0
Advanced			
Chipset-SATA Controller Configuration Chipset SATA SATA Hode Selection SATA Interface Speed SATA Port 0 SATA Port 1	<enabled> <ahci> <gen3> [Not Installed] [Not Installed]</gen3></ahci></enabled>		Enables or Disables the Chipset SATA Controller. The Chipset SATA controller supports the 2 black internal SATA ports (up to 6Gb/s supported per port).
FI Help t/1 Selec: Esc Exit +/+ Selec:	Litem F5 Litem En	/F6 Change Values Ner Select⊧SubMenu	F9 Setup Defaults F10 Save and Exit

Manage SATA settings to control internal storage interfaces and improve drive performance:

- Chipset SATA: Toggle the SATA controller to enhance system compatibility and power management with options for Enabled (default) or Disabled.
- SATA Mode Select: Note that the Arrakis MK3 operates exclusively in AHCI mode, ensuring modern storage performance and features.
- SATA Interface Speed: Choose the operation speed of the SATA ports to match your drive capabilities for improved data transfer rates. Available speeds are Gen1, Gen2, and Gen3 (default).



8.6.5 Thermal Configuration

	Insyd	leH20 Setup Utility	Rev. 5.0
Advanced			
Advanced Inernal Configuration Parameters Critical Trip Point Passive Trip Point	<110 C> <105 C>		Rev. 6.0 This value controls the temperature of the ACPI Critical Trip Point - the point in which the OS will shut the system off. NOTE: 100C is the Plan Of Record (POR) for all Intel mobile processors.
Fl Help 1/4 Esc Exit +/+	Select Iten Select Iten	F5/F6 Change Values Enter Select ► SubHenu	F9 Setup Defaults F10 Save and Exit

Adjust the system's thermal settings to optimize performance and prevent overheating:

- Thermal Configuration Parameters: Manage the system's temperature thresholds that determine at which temperatures the OS will take critical actions.
- Critical Trip Point: Set at a default of 110°C, this is the temperature at which the system will shut down to prevent damage.
- **Passive Trip Point**: Set at a default of 105°C, this is the temperature at which the system begins to throttle CPU frequency to reduce heat generation.



8.6.6 SIO FINETEK 81801U Configuration

	Insydel	420 Setup Utility	Rev. 5.0
Advanced			
Serial Port A Base 1/0 Address Interrupt Serial Hode Serial Port B Base 1/0 Address Interrupt Serial Hode Power Fail Hardware Honitor	<pre></pre>		Configure Serial port using options : [Disable] No Configuration [Enable] User Configuration
F1 Help Esc Exit	1/1 Select Item +/+ Select Item	F5/F6 Change Values Enter Select ► Sublienu	F9 Setup Defaults F10 Save and Exit

Configure serial port settings and power failure responses for system stability and expanded connectivity:

- Serial Port A/B: Enable or disable COM ports as required, with both ports enabled by default.
- Base IO Address / Interrupt: Customize the I/O addresses and interrupts for each serial port with options such as:
 - IO=3F8h; IRQ=4 for Port A (default)
 - IO=2F8h; IRQ=3 for Port B (default)
- Serial Mode: Select between RS232 (default) and RS485 modes, the latter includes auto flow control for RS485.
- Power Failure Settings:
 - Keep state (default): Maintains the system's last state in case of power disruption.
 - Always on: System reboots automatically after power restoration.
 - Always off: System stays off after power loss.
- Hardware Monitor: Monitors and displays crucial system voltage and temperature readings, providing real-time data to safeguard the system's operational health.



8.7 Security Settings

	InsydeH20) Setup Utility	Rev. 5.0
Hain Advanced Security Powe	er Boot Exit		
Supervisor Password	Not Installed		Install or Change the password and the length of password must be greater than one character.
Set Supervisor Password			
C1 Help	til Select Item	E5/E6 Channa Values	EQ. Sotup Dofaulte
Esc Exit	+/+ Select Item	Enter Select Sublienu	F10 Save and Exit

Set up a Supervisor password to enhance system security:

- 1. Select Supervisor Password: Opens a dialog to create a new password.
- 2. Create Password: Enter a password between 3 and 10 characters long.
- 3. **Confirm**: Press the Enter key to set the password.



8.8 Power Management

		Insyde	H20 Setup Utility		Rev. 5.0
Hain Advanced	Security Power Boot	t Exit			
Wake On Lan ACP1 S3		<disabled> <disabled></disabled></disabled>		Enable or Disable the	Vake On Lan
F1 Help Esc Exit	1/1 Se +/+ Se	lect Iten lect Iten	F5/F6 Change Values Enter Select ► SubHenu	F9 Setup Defa F10 Save and B	ults Exit

Configure settings to manage power and wake capabilities:

- Wake on LAN: Enable the system to wake from sleep states (S3 or S5) via LAN.
 - Options: S3, S5, S3 / S5, Disabled (default)
- ACPI S3 Support: Decide if the system should support the ACPI S3 sleep state for energy saving.
 - Options: Enabled, Disabled (default)



8.9 Boot Configuration

	Insyd	leH20 Setup Utility		Rev. 5.0
Hain Advanced Security Power	Boot Exit			
Boot Type Quiet Boot Network Stack PXE Boot capability	<uef1 boot="" typ<br=""><enabled> <disabled> <disabled></disabled></disabled></enabled></uef1>	62	Disables or enables booting in	Text Mode.
NCC 1				
F1 Help 1 Esc Exit +	/4 Select Iten /4 Select Iten	F5/F6 Change Values Enter Select ► SubMenu	F9 Setup Defaults F10 Save and Exit	

Manage settings that control the system's boot operations:

- Boot Type: Specifies that the Arrakis MK3 supports UEFI Boot only.
- Quiet Boot: Controls the display of messages during boot.
 - Options: Enabled (default), Disabled
- Network Stack: Enable this if using PXE functionality; otherwise, it should be disabled (default).
- **PXE Boot Capability**: Sets the protocol for PXE operations.
 - Options: Disabled (default), UEFI: IPv4, UEFI: IPv6
- EFI Device Priority: Determines which EFI-enabled storage device the system should boot from.



8.10 Exit Options

		InsydeH20 Setup Utility	Rev. 5.0
Main Advanced Security P	ower Boot Exit		
Main Advanced Security P Exit Saving Changes Save Change Without Exit Exit Discarding Changes Load Optimal Defaults Discard Changes	hower Boot Exit	InsydeH20 Setup Utility	Rev. 5.0
	the Collect Litre	F6/F6 Channe Values	EQ. Solution Endersite
Esc Exit	+/+ Select Item	Enter Select > Sublienu	F10 Save and Exit

Manage your BIOS settings changes efficiently with these exit options:

- Exit Saving Changes: Saves all modifications and reboots the system, applying the new settings.
- Save Changes Without Exit: Saves your changes without rebooting, allowing you to continue adjusting settings.
- Exit Discarding Changes: Exits the BIOS without saving, reverting to previously saved settings, and reboots the system.
- Load Optimal Defaults: Resets the BIOS to the factory settings, which are optimized for general use.
- Discard Changes: Cancels any unsaved changes, reverting to the last saved configurations.



9 Driver Installation Guidance

The Arrakis MK3 typically comes with an Operating System preinstalled for optimal performance.

Should you need to install or reinstall the operating system or other software on the Arrakis MK3 without a preinstalled system, all necessary drivers are readily available for download. Simply scan the QR code provided or visit the link below to access the full range of system drivers:



Download Drivers

To install the drivers, follow the on-screen instructions provided by the driver installation programs. This ensures your system is up-to-date and functioning efficiently.



10 Appendix A: Power Consumption Overview

This appendix outlines the power consumption metrics for the Arrakis MK3 system under various operating conditions. The specific hardware configurations and operating parameters used during testing are listed below. These results should be considered as a reference only, as actual power consumption can vary based on software and hardware options.

Hardware Configuration:

- CPU: Intel Atom E3950
- Memory: 4GB DDR3L at 1866MHz
- Operating System: Windows 10 IoT 2019 LTSC
- Storage: 64GB mSATA
- Benchmarking Tool: Passmark

Power Consumption Measurements:

Voltage	Power Off	Startup (Max)	Startup (Stable)	Burn-in (Max)	Shutdown
12V	0.14A	0.95A	0.62A	1.10A	0.82A
24V	0.09A	0.50A	0.32A	0.57A	0.42A

Note: Power consumption values depend significantly on the configuration and usage of the system.



11 Appendix B: F75111N DIO & Watchdog Device

The Arrakis MK3, equipped with optional DIO ports, supports enhanced functionality through the use of a watchdog timer. This section provides guidance on how to program and utilize these features effectively.

11.1 Watchdog Timer Usage in DOS

The necessary software resources for programming the watchdog timer can be accessed from the Driver Download section:

- Source File: F75111_Dos_Src.rar
- Binary File: F75111_Dos_Bin.rar
- Access Credentials: Username & Password: sf

11.1.1 Steps to Utilize the Demo Application:

- 1. Boot into the MS-DOS operating system.
- 2. Run the 75WDT.EXE executable file.
- 3. Enter 1 to activate the watchdog timer, or 0 to deactivate it.
- 4. Specify the countdown duration in seconds for the timer, which will subsequently reset the computer.



11.1.2 Programming Example:

Below are examples of how to interact with the watchdog timer using I2C communication:

Activate and set the watchdog timer:

```
WriteI2CByte(I2CADDR, CONFIG, 0x03); // Configure watchdog timer function
WriteI2CByte(I2CADDR, WDT_TIMER, timer); // Set timer range 0-255 seconds
WriteI2CByte(I2CADDR, WDT_TIMER_CTL, 0x73); // Enable timer in second and pulse mode
```

Deactivate the watchdog timer:

```
WriteI2CByte(I2CADDR, WDT_TIMER_CTL, 0x00); // Disable watchdog timer
```



• Sample code to pause operation using assembly language:

```
void pause(int time) {
    asm mov ah, Oh; // Set to read system time counter
    asm int 1ah; // Read time from counter, store in DX
    asm add dx, time;
    asm mov bx, dx;
label:
    asm int 1ah;
    asm cmp bx, dx;
    asm jne label;
}
```

11.2 Watchdog Timer and DIO Configuration

You can find the necessary software resources in the Driver Download section under the DIO folder:

- Source File: F75111_DIOSrc.rar
- Binary File: F75111_DemoBin.rar
- Access Credentials: Username & Password: sf



11.2.1 Using the Demo Application

usioniize (JII	I Auui	.833			-	_		
Input y	ourcu	stomiz	e addr	ess : 0:	×			
DIO Test				_	-	-		_
🖉 di/do te	ST(LO)						
🖉 di/do te	ST(HI)				1			
	7	б	5	4	3	2	1	0
DO Status :	0	0	0	0	0	0	0	C
DI Status :	0	0	0	0	0	0	0	C
							Start	
VDT Test			_		_	_		-
Enable		10	1	Dissi	Le:			
Enable L	oop		E					

To test and configure the DIO and Watchdog Timer functions, follow these steps:

- 1. Click the Start button to begin testing the DIO functionality.
- 2. Click the Enable button to activate the Watchdog Timer (WDT).
- 3. Click the Disable button to deactivate the WDT.
- 4. To conduct a loop test, check the Enable Loop box and press Enable.
- 5. Use the Install WDT button to configure the system to auto-run this application at boot. Click again to remove the auto-run setting. An icon indicates when this setting is active.





11.2.2 Command Functions

- Watchdog Timer Initialization: Configure the initial internal F75111 port settings and enable necessary functions.
- Digital Output (DO): Set digital output values.
- Digital Input (DI): Retrieve digital input values.
- Watchdog Timer Enable/Disable: Activate or deactivate the Watchdog Timer.

Examples of Code Implementation:

1. Initialize Watchdog Timer and Ports:

```
// Initialize F75111 internal settings for input and output configurations
InitInternalF75111();
```

2. Set Output Values:

```
// Output a specific byte value to digital output
InterDigitalOutput(byteValue);
```

3. Retrieve Input Values:

```
// Get input values from digital input
BYTE inputStatus = InterDigitalInput();
```

4. Manage Watchdog Timer:

```
// Enable the Watchdog Timer with a specific timeout
F75111_SetWDTEnable(timerValue);
// Disable the Watchdog Timer
F75111_SetWDTDisable();
```

11.3 IO Device: F75111 VB6 under Windows

You can find the necessary software resources in the Driver Download section under the DIO folder:

- Source File: 75111_VB_v10.rar
- Binary File: 75111_VB_Src.rar111_DemoBin.rar
- Access Credentials: Username & Password: sf



11.3.1 How to Use the Demo Application

■ 75111_DE	MO VB v1.0		
Please key-in th	e timer by sec II A Enable WDT	B Disable WDT	
Please key-in th	e DO Value by h Set DO Value	ex	
Push the Button	will show the DI 1	×_3X Value II	
D Check DI Valu	e 1X Value 2X Value		

A. Enable WDT Timer: Enter the desired time in seconds, then the system will reboot after the specified time. B. Disable WDT Timer: Press the button to clear the WDT timer value. C. Set DO Value: Enter the DO value in hexadecimal and press the button. D. Check DI Value: The right-side text boxes display the DI 1X & 2X values when the button is pressed.

11.3.2 SDK Function Introduction

Function EnableWDT:

```
Function EnableWDT(timer As Integer)
Call WriteI2CByte(&H3, &H3)
Call WriteI2CByte(&H37, timer)
Call WriteI2CByte(&H36, &H73)
End Function
```

Function DisableWDT:



Function DisableWDT()
Call WriteI2CByte(&H36, &H0)
End Function

Function SetDOValue:

```
Function SetDOValue(dovalue As Integer)
Call WriteI2CByte(&H23, &H0)
Call WriteI2CByte(&H20, &HFF)
Call WriteI2CByte(&H2B, &HFF)
Call WriteI2CByte(&H21, dovalue)
End Function
```

Function CheckDIValue:

```
Function CheckDIValue()
Dim GPI01X As Integer
Dim GPI03X As Integer
Dim DI1Xhex As String
Call ReadI2CByte(&H12, GPI01X)
Call ReadI2CByte(&H42, GPI03X)
DI1Xhex = Hex(GPI01X)
DI3Xhex = Hex(GPI03X)
Text3.Text = "0x" + DI1Xhex
Text4.Text = "0x" + DI3Xhex
End Function
```

11.4 Watchdog Timer and DIO under Linux

You can find the necessary software resources in the Driver Download section under the DIO folder:

- Source File: F75111v2.0L.tar.gz
- Binary File: F75111v2.0LBin.tar.gz
- Access Credentials: Username & Password: sf

11.4.1 How to Compile Source Code

1. Compile Source Code with Code::Blocks

- Install Code::Blocks with the command: apt-get install codeblocks
- Open the existing project (F75111.cbp) in Code::Blocks and click the compile button
- Add the option 'pkg-config --libs gtk+-2.0 gthread-2.0' in Project->Build Options->Linker Settings->Other linker options
- 2. Compile Source Code with make
 - Navigate to the F75111 directory: cd F75111
 - Compile the source code: make
 - Execute the binary file: src/f75111



11.4.2	How to	Use the	Demo	Application
--------	--------	---------	------	-------------

1		177	511	117	2.0	Ε.				
Customize	F751]	L1 A	ddre	ess	:	0×	90			
			DIC) Te	st					
DI / DO Test	t (Lov	()						0	%	
DI / DO Test	t (Hig	h)						0	%	
	7	6	5	4	3	2	1	0		
DO Status			0			0	0			
DI Status									-	_
									L	Start
		-	WD	т Те	st					
Enable	10		ľ	Disa	üle;					
🗌 Enable I	Loop 1	Test							C	Install
WDT Stand	hv								T	Uninstall

- 1. Press the Start button to test the DIO function
- 2. Press the ${\tt Enable}$ button to test the WDT function
- 3. Press the Disable button to disable the WDT
- 4. Check the Enable Loop box and press Enable to perform a WDT loop test
- 5. Press Install to set the system to autorun this application when booting, and press Uninstall to remove it from autorun
- 6. If WDT is enabled, the system icon will blink





F75111 will send F75111_SetWDTEnable(BYTE byteTimer) with a parameter timer. If there is no disable signal (F75111_SetWDTDisable()) before the timer counts down to 0, the system will reboot. If a disable signal is received, it will resend the enable WDT signal to prevent a reboot loop.

11.4.3 Introduction

IO Function in SMBus.c:

```
void SMBusIoWrite(BYTE byteOffset, BYTE byteData) {
    outb(byteData, m_SMBusMapIoAddr + byteOffset);
}
BYTE SMBusIoRead(BYTE byteOffset) {
    DWORD dwAddrVal;
    dwAddrVal = inb(m_SMBusMapIoAddr + byteOffset);
    return (BYTE)(dwAddrVal & 0xOFF);
}
```

Initialize Internal F75111:

```
void F75111::InitInternalF75111() {
    this->Write_Byte(F75111_INTERNAL_ADDR, GPI01X_CONTROL_MODE, 0x00); // Set GPI01X to Input_
    function
    this->Write_Byte(F75111_INTERNAL_ADDR, GPI03X_CONTROL_MODE, 0x00); // Set GPI03X to Input_
    function
    this->Write_Byte(F75111_INTERNAL_ADDR, GPI02X_CONTROL_MODE, 0xFF); // Set GPI02X to Output_
    function
    this->Write_Byte(F75111_INTERNAL_ADDR, F75111_CONFIGURATION, 0x03); // Enable WDT OUT function
}
```

Set Output Value:

```
void F75111::InterDigitalOutput(BYTE byteValue) {
   BYTE byteData = 0;
   byteData = (byteData & 0x01) ? byteValue + 0x01 : byteValue;
   byteData = (byteData & 0x02) ? byteValue + 0x02 : byteValue;
   byteData = (byteData & 0x04) ? byteValue + 0x04 : byteValue;
   byteData = (byteData & 0x80) ? byteValue + 0x08 : byteValue;
   byteData = (byteData & 0x40) ? byteValue + 0x10 : byteValue;
   byteData = (byteData & 0x20) ? byteValue + 0x20 : byteValue;
   byteData = (byteData & 0x20) ? byteValue + 0x20 : byteValue;
   byteData = (byteData & 0x20) ? byteValue + 0x40 : byteValue;
   byteData = (byteData & 0x08) ? byteValue + 0x40 : byteValue;
   byteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
   byteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
   dyteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
   dyteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
   dyteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
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   dyteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
   dyteData = (byteData & 0x08) ? byteValue + 0x80 : byteValue;
   dyteData = (byteData & 0x08) ? byteValue;
   dyteData = (byteData & 0x08) ? byteValue;
   dyteData = (byteData
```



Get Input Value:

```
BYTE F75111::InterDigitalInput() {
   BYTE byteGPIO1X = 0;
    BYTE byteGPIO3X = 0;
   BYTE byteData = 0;
   this->Read_Byte(F75111_INTERNAL_ADDR, GPI01X_INPUT_DATA, &byteGPI01X); // Get value from GPI01X
    this->Read_Byte(F75111_INTERNAL_ADDR, GPIO3X_INPUT_DATA, &byteGPIO3X); // Get value from GPIO3X
   byteGPI01X = byteGPI01X & 0xF0; // Mask unuseful value
    byteGPIO3X = byteGPIO3X & OxOF; // Mask unuseful value
    byteData = (byteGPI01X & 0x10) ? byteData + 0x01 : byteData;
    byteData = (byteGPIO1X & 0x80) ? byteData + 0x02 : byteData;
    byteData = (byteGPIO1X & 0x40) ? byteData + 0x04 : byteData;
    byteData = (byteGPIO3X & 0x01) ? byteData + 0x08 : byteData;
   byteData = (byteGPIO3X & 0x02) ? byteData + 0x10 : byteData;
    byteData = (byteGPIO3X & 0x04) ? byteData + 0x20 : byteData;
    byteData = (byteGPIO3X & 0x08) ? byteData + 0x40 : byteData;
    byteData = (byteGPIO1X & 0x20) ? byteData + 0x80 : byteData; // Get correct DI value from
→ GPIO1X & GPIO3X
    return byteData;
}
```

Enable WatchDog:

Disable WatchDog:

```
void F75111_SetWDTDisable() {
    WriteByte(F75111_INTERNAL_ADDR, WDT_CONFIGURATION, 0x00); // Disable WatchDog
}
```